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October 2014

FDMS86163P

P-Channel PowerTrench® MOSFET
-100 V, -50 A, 22 mΩ

Features

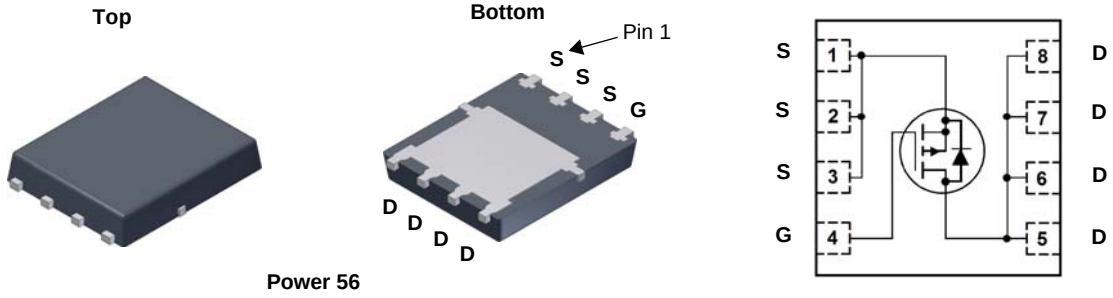
- Max $r_{DS(on)}$ = 22 mΩ at V_{GS} = -10 V, I_D = -7.9 A
- Max $r_{DS(on)}$ = 30 mΩ at V_{GS} = -6 V, I_D = -5.9 A
- Very low RDS-on mid voltage P-channel silicon technology optimised for low Qg
- This product is optimised for fast switching applications as well as load switch applications
- 100% UIL tested
- RoHS Compliant

General Description

This P-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Applications

- Active Clamp Switch
- Load Switch



Power 56

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units
V_{DS}	Drain to Source Voltage			-100	V
V_{GS}	Gate to Source Voltage			±25	V
I_D	Drain Current -Continuous	T_C = 25 °C		-50	A
	-Continuous	T_A = 25 °C	(Note 1a)	-7.9	
	-Pulsed		(Note 4)	-100	
E_{AS}	Single Pulse Avalanche Energy		(Note 3)	486	mJ
P_D	Power Dissipation	T_C = 25 °C		104	W
	Power Dissipation	T_A = 25 °C	(Note 1a)	2.5	
T_J, T_{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.2	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86163P	FDMS86163P	Power 56	13 ”	12 mm	3000 units

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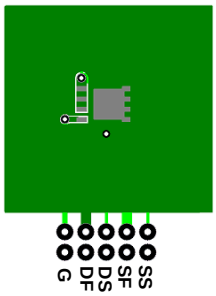
Electrical Characteristics T_J = 25 °C unless otherwise noted

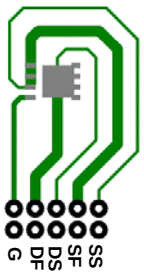
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain to Source Breakdown Voltage	I_D = -250 μA, V_{GS} = 0 V	-100			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = -250 μA, referenced to 25 °C		-59		mV/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = -80 V, V_{GS} = 0 V			-1	μA
I_{GSS}	Gate to Source Leakage Current	V_{GS} = ±25 V, V_{DS} = 0 V			±100	nA
On Characteristics						
$V_{GS(th)}$	Gate to Source Threshold Voltage	V_{GS} = V_{DS}, I_D = -250 μA	-2	-2.8	-4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = -250 μA, referenced to 25 °C		6.2		mV/°C
$r_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = -10 V, I_D = -7.9 A		17.8	22	mΩ
		V_{GS} = -6 V, I_D = -5.9 A		21.3	30	
		V_{GS} = -10 V, I_D = -7.9 A,T_J = 125 °C		29	36	
g_{FS}	Forward Transconductance	V_{DS} = -10 V, I_D = -7.9 A		29		S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = -50 V, V_{GS} = 0 V, f = 1 MHz		3070	4085	pF
C_{oss}	Output Capacitance			501	670	pF
C_{rss}	Reverse Transfer Capacitance			21	35	pF
R_g	Gate Resistance		0.1	2.6	5.3	Ω
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = -50 V, I_D = -7.9 A, V_{GS} = -10 V, R_{GEN} = 6 Ω		17	30	ns
t_r	Rise Time			8.8	18	ns
$t_{d(off)}$	Turn-Off Delay Time			33	53	ns
t_f	Fall Time			6.9	14	ns
Q_g	Total Gate Charge	V_{GS} = 0 V to -10 V; V_{DD} = -50 V, I_D = -7.9 A		42	59	nC
Q_g	Total Gate Charge	V_{GS} = 0 V to -6 V; V_{DD} = -50 V, I_D = -7.9 A		26	37	nC
Q_{gs}	Gate to Source Charge	V_{DD} = -50 V, I_D = -7.9 A		11.8		nC
Q_{gd}	Gate to Drain “Miller” Charge			7.1		nC
Drain-Source Diode Characteristics						
V_{SD}	Source to Drain Diode Forward Voltage	V_{GS} = 0 V, I_S = -7.9 A (Note 2)		-0.81	-1.3	V
		V_{GS} = 0 V, I_S = -2 A (Note 2)		-0.75	-1.2	
t_{rr}	Reverse Recovery Time	I_F = -7.9 A, di/dt = 100 A/μs		63	102	ns
Q_{rr}	Reverse Recovery Charge			132	210	nC

Notes:

1. $R_{\theta JA}$ is determined with the device mounted on a 1 in^2 pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a) 50 °C/W when mounted on a 1 in^2 pad of 2 oz copper



b) 125 °C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.
3. Starting T_J = 25 °C; P-ch: L = 3 mH, I_{AS} = -18 A, V_{DD} = -100 V, V_{GS} = -10 V. 100% test at L = 0.1 mH, I_{AS} = -58 A.
4. Pulse Id refers to Figure.11 Forward Bias Safe Operation Area.

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Typical Characteristics T_J = 25 °C unless otherwise noted

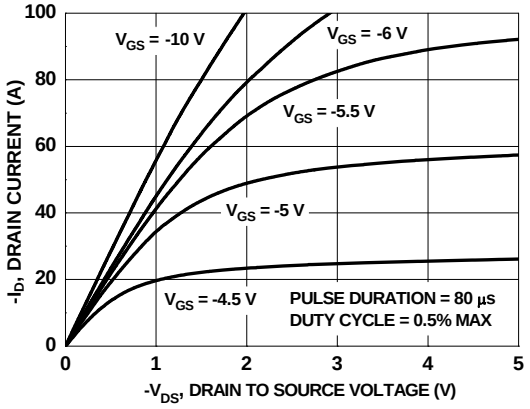

Figure 1. On Region Characteristics

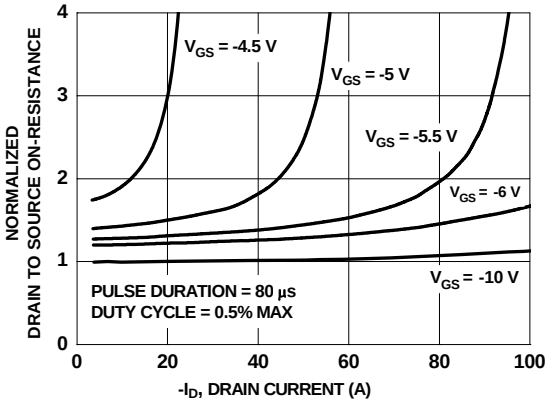

Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

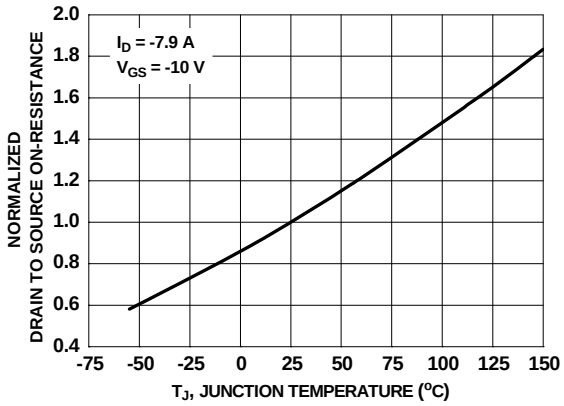

Figure 3. Normalized On Resistance vs Junction Temperature

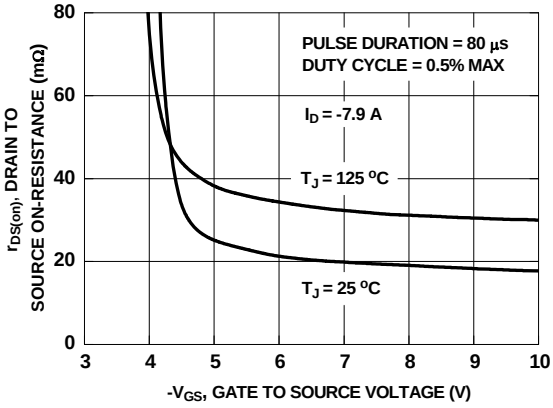

Figure 4. On-Resistance vs Gate to Source Voltage

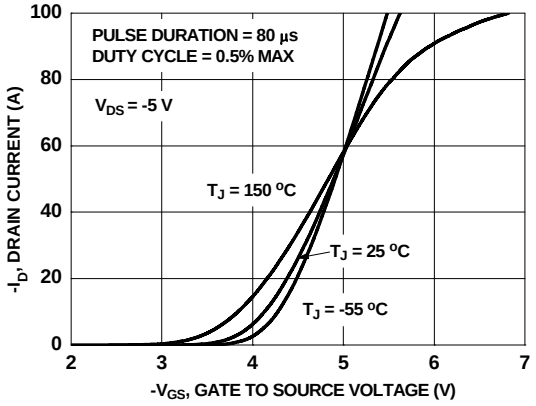

Figure 5. Transfer Characteristics

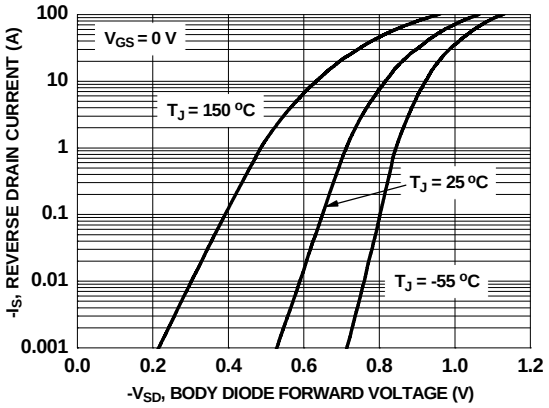

Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics T_J = 25 °C unless otherwise noted

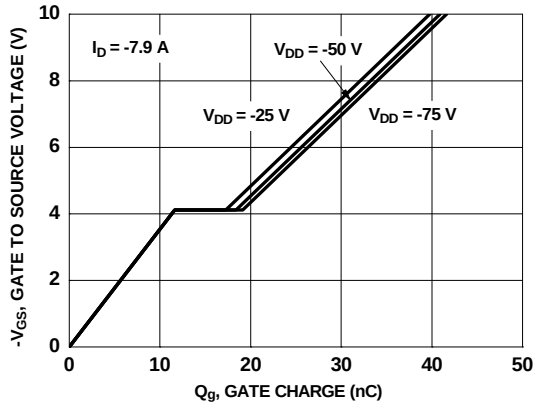

Figure 7. Gate Charge Characteristics

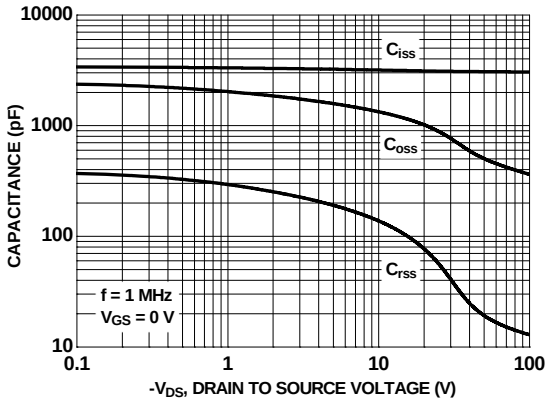

Figure 8. Capacitance vs Drain to Source Voltage

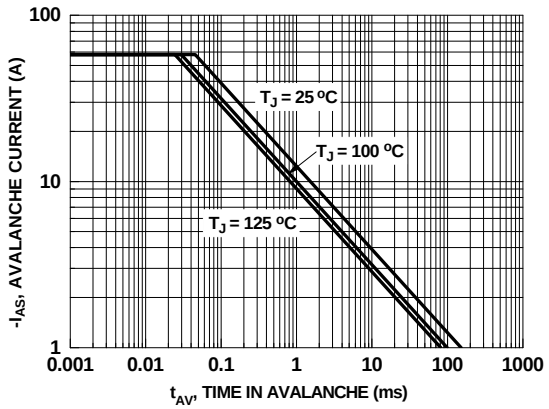

Figure 9. Unclamped Inductive Switching Capability

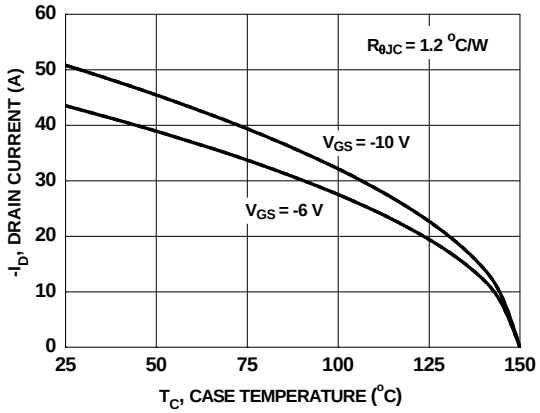

Figure 10. Maximum Continuous Drain Current vs Case Temperature

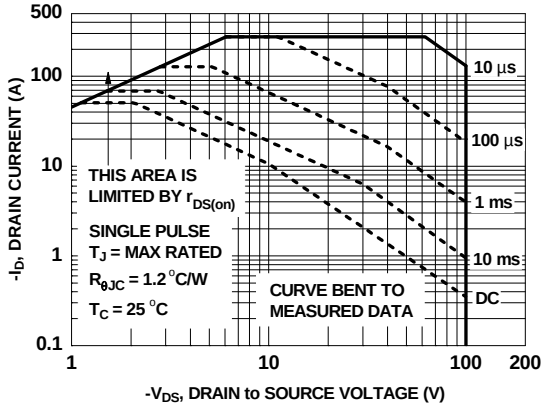

Figure 11. Forward Bias Safe Operating Area

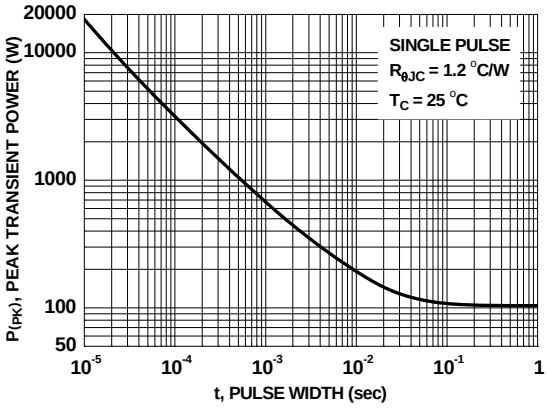

Figure 12. Single Pulse Maximum Power Dissipation

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Typical Characteristics T_J = 25 °C unless otherwise noted

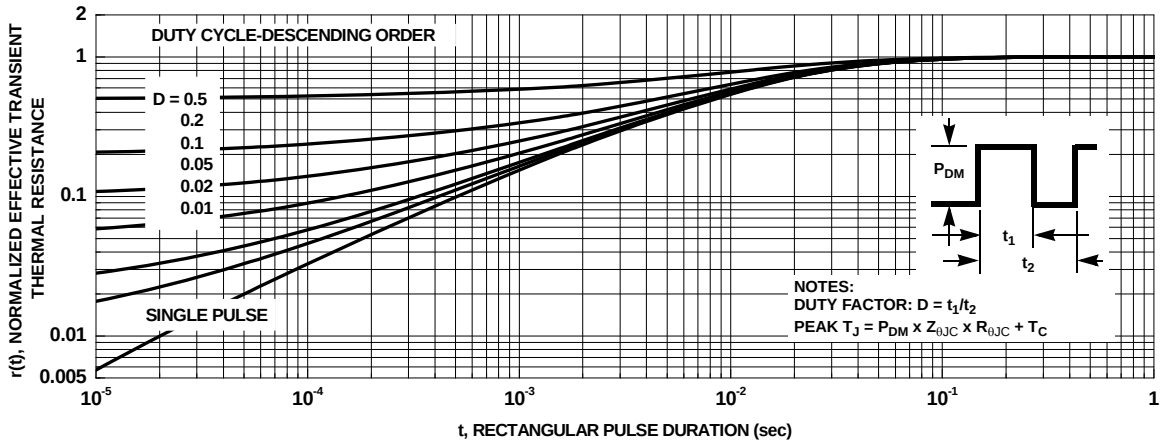
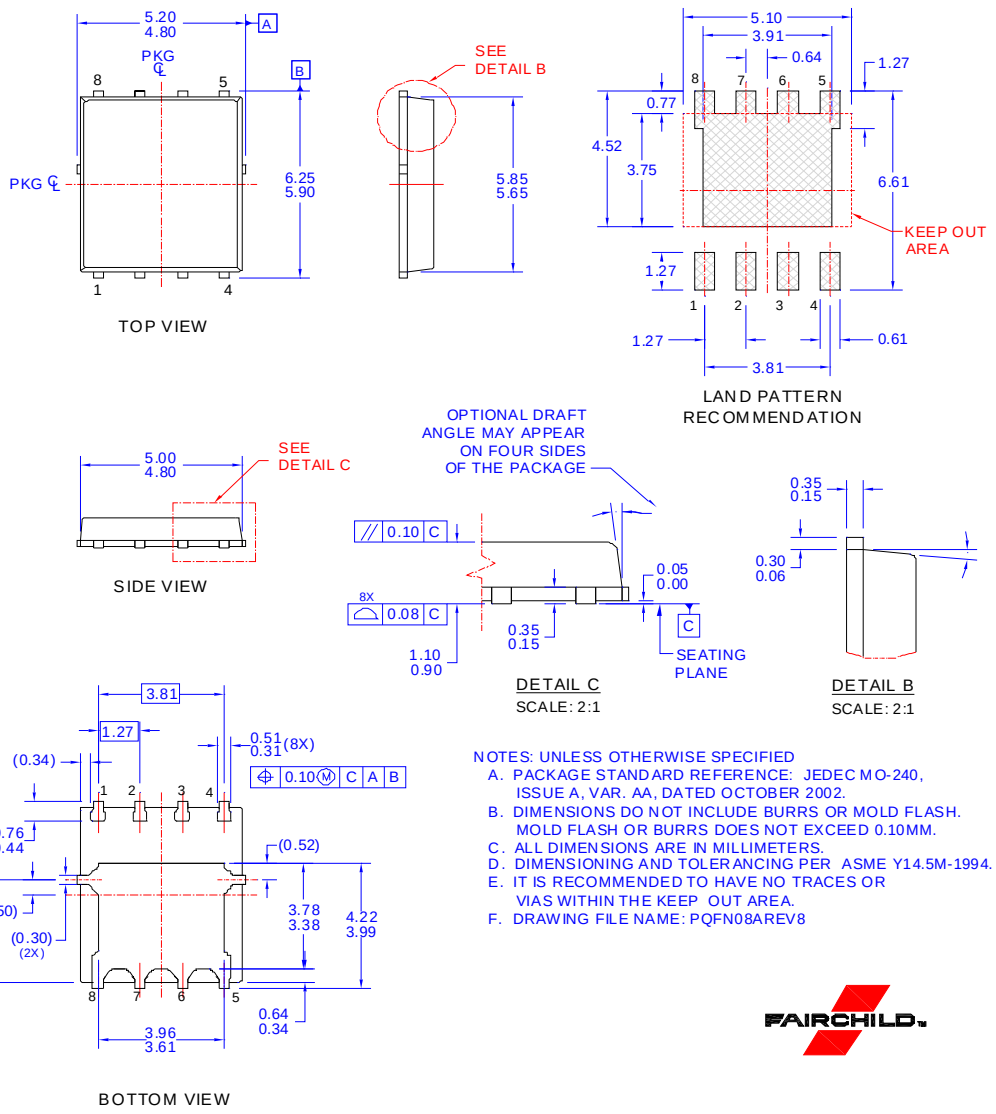


Figure 13. Junction-to-Case Transient Thermal Response Curve

Dimensional Outline and Pad Layout



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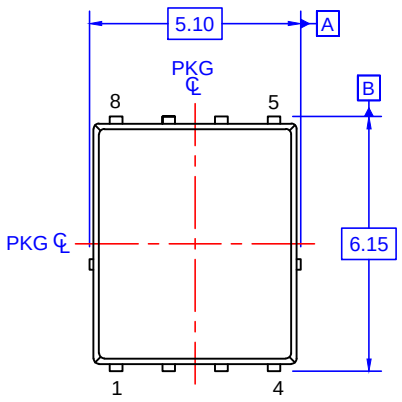
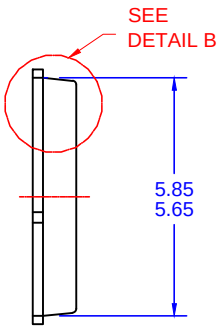
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

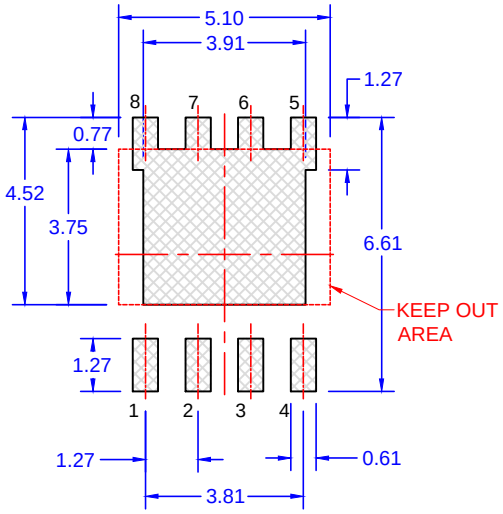
Rev. I71

PQFN8 5X6, 1.27P
CASE 483AE
ISSUE A

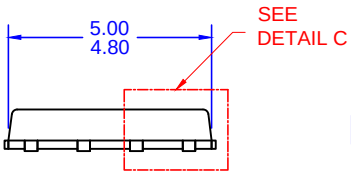


TOP VIEW

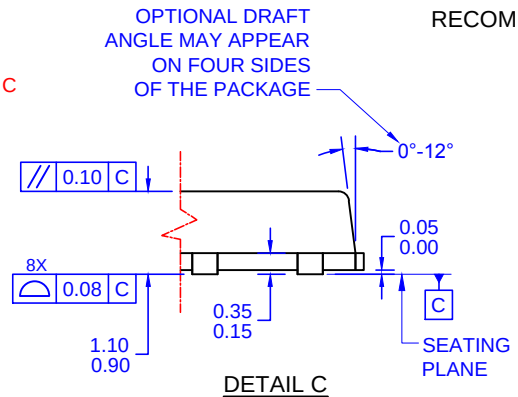




LAND PATTERN
RECOMMENDATION



SIDE VIEW



DETAIL C
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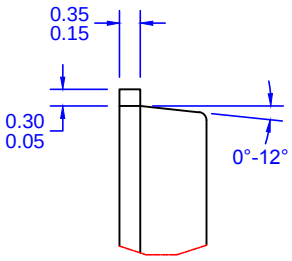

DETAIL B
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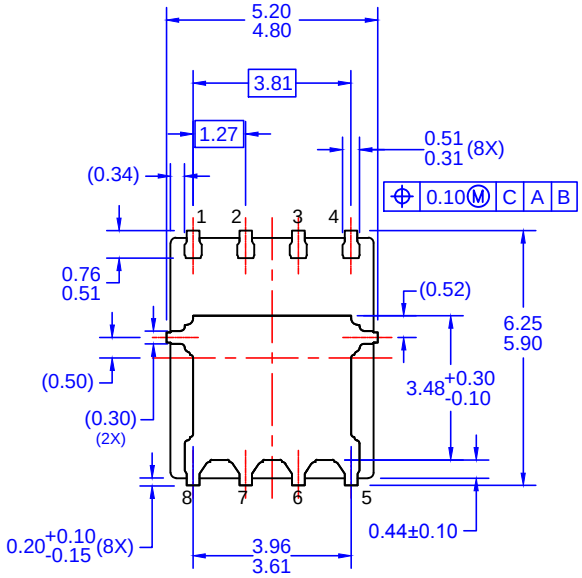

BOTTOM VIEW

NOTES: UNLESS OTHERWISE SPECIFIED

A. PACKAGE STANDARD REFERENCE: JEDEC MO-240, ISSUE A, VAR. AA,.
B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10MM.
C. ALL DIMENSIONS ARE IN MILLIMETERS.
D. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.
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